1A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS		
PARAMETER	**VALUE**	**UNIT**
I_F	1	A
V_{RRM}	200 - 1000	V
I_{FSM}	30	A
$T_{J\ MAX}$	150	°C
Package	Thin SMA	
Configuration	Single die	

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application

Pb-Free RoHS COMPLIANT HALOGEN FREE

Thin SMA

MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

PARAMETER		SYMBOL	RS1D ALH	RS1G ALH	RS1J ALH	RS1K ALH	RS1M ALH	UNIT
Marking code on the device			RS1DAH	RS1GAH	RS1JAH	RS1KAH	RS1MAH	
Repetitive peak reverse voltage		V_{RRM}	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I_F	1					A
Surge peak forward current, single half sine-wave superimposed on rated load	t = 8.3ms	I_{FSM}	30					A
	t = 1.0ms		100					A
Junction temperature		T_J	-55 to +150					°C
Storage temperature		T_{STG}	-55 to +150					°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	19	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	81	°C/W
Junction-to-case thermal resistance	$R_{\Theta JC}$	19	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage[1]	RS1DALH RS1GALH RS1JALH	I_F = 0.5A, T_J = 25°C	V_F	0.90	-	V
		I_F = 1.0A, T_J = 25°C		0.97	1.30	V
		I_F = 0.5A, T_J = 125°C		0.75	-	V
		I_F = 1.0A, T_J = 125°C		0.83	0.94	V
	RS1KALH RS1MALH	I_F = 0.5A, T_J = 25°C		0.96	-	V
		I_F = 1.0A, T_J = 25°C		1.04	1.30	V
		I_F = 0.5A, T_J = 125°C		0.80	-	V
		I_F = 1.0A, T_J = 125°C		0.90	1.11	V
Reverse current @ rated V_R[2]		T_J = 25°C	I_R	-	1	μA
		T_J = 125°C		-	33	μA
Reverse recovery time	RS1DALH RS1GALH	I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A	t_{rr}	-	150	ns
	RS1JALH			-	250	ns
	RS1KALH RS1MALH			-	500	ns
Junction capacitance		1MHz, V_R = 4.0V	C_J	7	-	pF

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE[1]	PACKAGE	PACKING
RS1xALH	Thin SMA	14,000 / Tape & Reel

Notes:

1. "x" defines voltage from 200V(RS1DALH) to 1000V(RS1MALH)

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

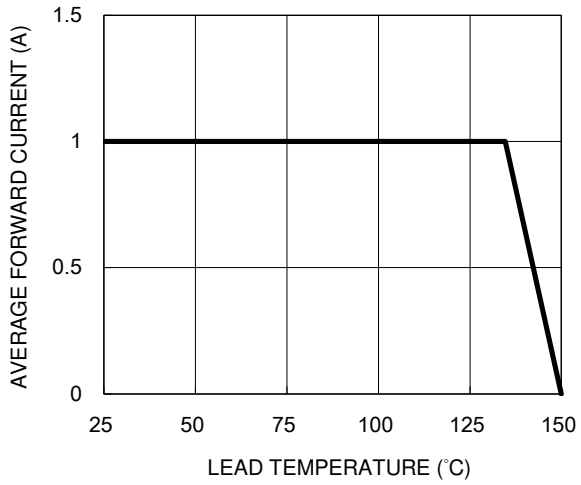


Fig.2 Typical Junction Capacitance

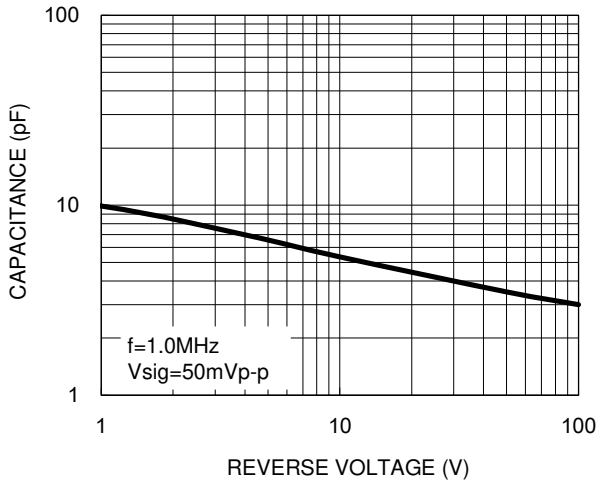


Fig.3 Typical Reverse Characteristics

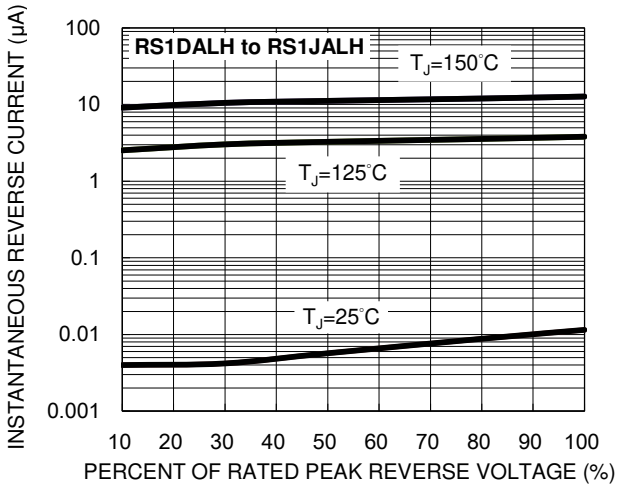


Fig.4 Typical Forward Characteristics

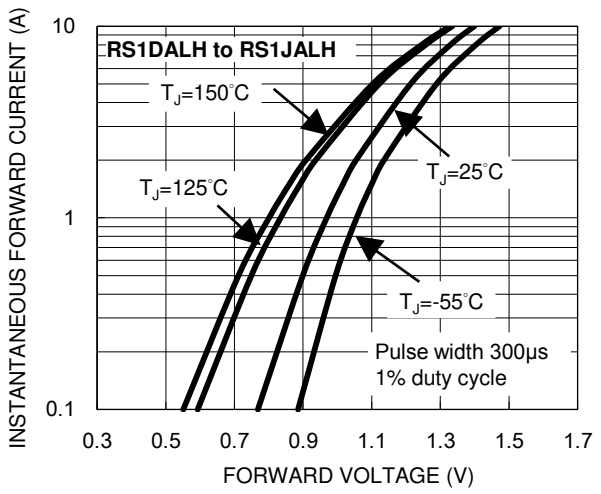


Fig.5 Typical Reverse Characteristics

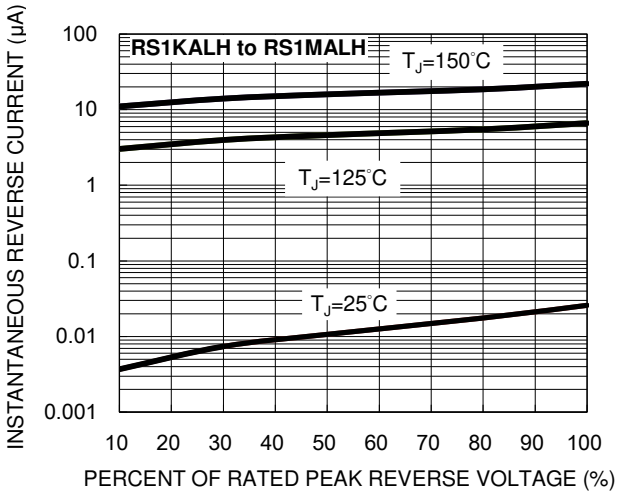
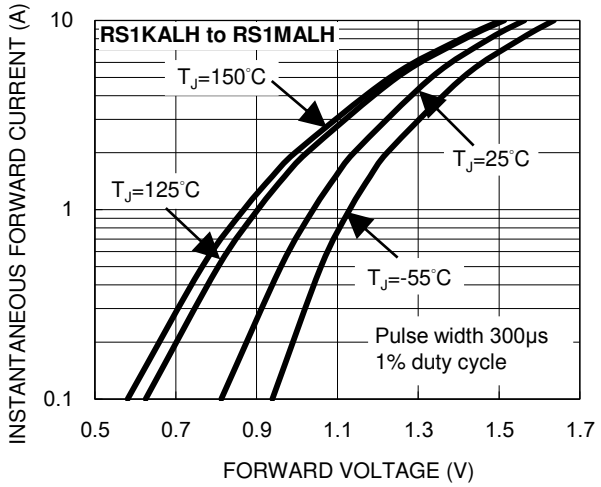


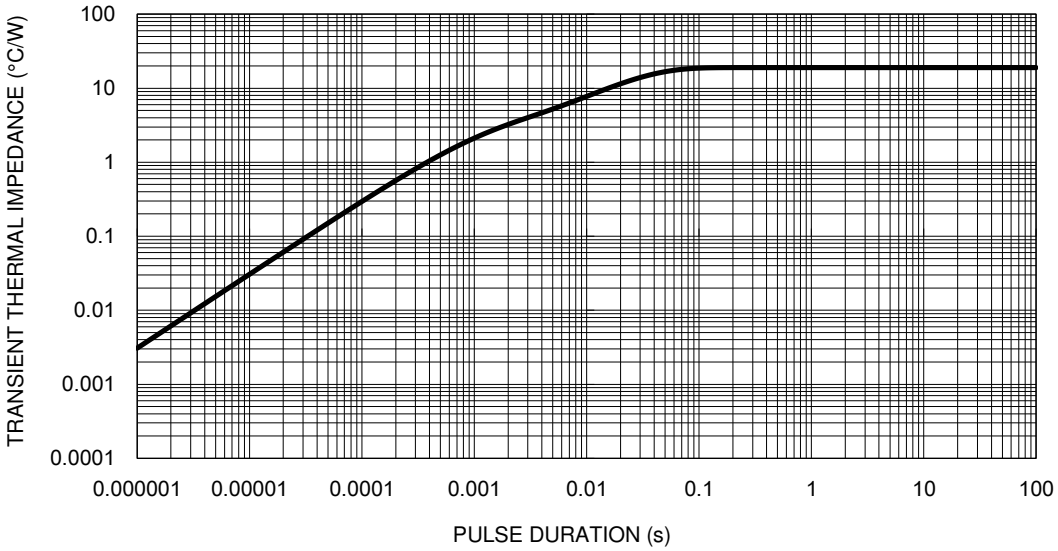
Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

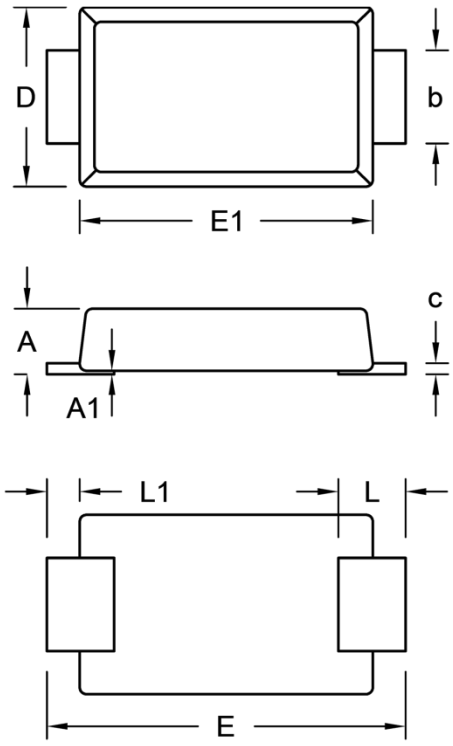
(T_A = 25°C unless otherwise noted)

Fig.7 Typical Transient Thermal Impedance



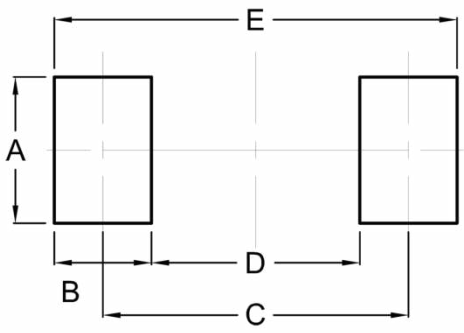
PACKAGE OUTLINE DIMENSIONS

Thin SMA



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
A	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
c	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	2.10	0.083
B	1.40	0.055
C	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM

P/N = Marking Code
YW = Date Code
F = Factory Code

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